

# **Description**

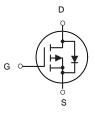
The SM4185T9RL uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

# D S S G TO-252-2L

### **General Features**

 $V_{DS} = -40V I_{D} = -50A$ 

 $R_{DS(ON)}$  < 19 m $\Omega$  @  $V_{GS}$ =10V



### P-Channel MOSFET

# **Application**

Battery protection

Load switch

Uninterruptible power supply

# **Package Marking and Ordering Information**

Product ID	Pack	Brand	Qty(PCS)
SM4185T9RL	TO252-2L(TO-252(DPAK))	HXY MOSFET	2500

## Absolute Maximum Ratings (T<sub>C</sub>=25 ℃ unless otherwise noted)

Symbol	Parameter	Rating	Units	
VDS	Drain-Source Voltage	-40		
VGS	Gate-Source Voltage	ate-Source Voltage ±20		
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	-50	А	
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	-22	А	
IDM	Pulsed Drain Current <sup>2</sup>	-140	А	
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation <sup>4</sup>	40.3	W	
TSTG	Storage Temperature Range	-55 to 150	°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	
ReJA	Thermal Resistance Junction-ambient <sup>1</sup>	nal Resistance Junction-ambient <sup>1</sup> 66		
R₀JC	Thermal Resistance Junction-Case <sup>1</sup>	ction-Case <sup>1</sup> 3.1		



# Electrical Characteristics (T<sub>J</sub> = 25°C, unless otherwise noted)

Parameter		Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static Characteristics							
Drain-Source Breakdown Volt	age	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-40	-	-	V
Gate-body Leakage current		Igss	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±20V		-	±100	nA
Zero Gate Voltage Drain Current	TJ=25°C	IDSS	V <sub>DS</sub> = -40V, V <sub>GS</sub> = 0V	-	-	-1	μΑ
	T <sub>J</sub> =100°C			-	-	-100	
Gate-Threshold Voltage		V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-1.0	-1.5	-2.2	V
		_	V <sub>GS</sub> = -10V, I <sub>D</sub> = -20A	-	13.5	19	
Drain-Source On-Resistance <sup>4</sup>		R <sub>DS(on)</sub>	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -15A	- 19.5 25		25	mΩ
Forward Transconductance <sup>4</sup>		<b>g</b> fs	V <sub>DS</sub> = -10V, I <sub>D</sub> = -20A		44	-	S
Dynamic Characteristics5	1			<u> </u>			
Input Capacitance		Ciss	V <sub>DS</sub> = -20V, V <sub>GS</sub> =0V, f =1MHz	-	2525	-	pF
Output Capacitance		Coss		-	190	-	
Reverse Transfer Capacitance		C <sub>rss</sub>		-	172	-	
Gate Resistance		Rg	f=1MHz	-	10	-	Ω
Switching Characteristics	5			<u> </u>			
Total Gate Charge		Qg		-	35	-	
Gate-Source Charge		Qgs	$V_{GS} = -10V, V_{DS} = -20V,$ $I_{D} = -20A$	-	5.5	-	nC
Gate-Drain Charge		Q <sub>gd</sub>		-	8	-	
Turn-On Delay Time		t <sub>d(on)</sub>		-	14.5	-	. ns
Rise Time		t <sub>r</sub>	$V_{GS} = -10V, V_{DD} = -20V,$	-	20.2	-	
Turn-Off Delay Time		t <sub>d(off)</sub>	$R_G = 3\Omega$ , $I_D = -20A$	-	32	-	
Fall Time		t <sub>f</sub>		-	10	-	
Drain-Source Body Diode	Character	istics	1		ı	1	
Diode Forward Voltage <sup>4</sup>		V <sub>SD</sub>	I <sub>S</sub> = -20A, V <sub>GS</sub> = 0V	-	-	-1.2	V
Continuous Source Current	T <sub>C</sub> =25°C	Is	-	_	-	-50	Α

# Note:

- 1. Repetitive rating, pulse width limited by junction temperature  $T_{J(MAX)}$ =150°C.
- 2. The EAS data shows Max. rating . The test condition is  $V_{DD}$ = -25V,  $V_{GS}$ = -10V, L= 0.1mH,  $I_{AS}$ = -34A.
- 3. The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.
- 4. The data tested by pulsed , pulse width  $\leq 300 us$  , duty cycle  $\leq 2\%.$
- $5. \ This \ value \ is \ guaranteed \ by \ design \ hence \ it \ is \ not \ included \ in \ the \ production \ test.$



# **Typical Characteristics**

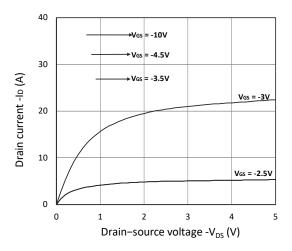


Figure 1. Output Characteristics

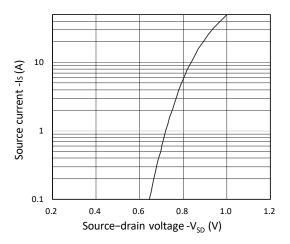


Figure 3. Forward Characteristics of Reverse

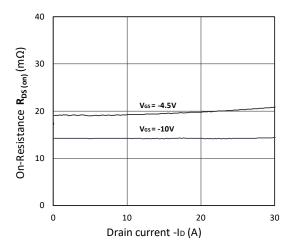


Figure 5.  $R_{DS(ON)}$  vs.  $I_D$ 

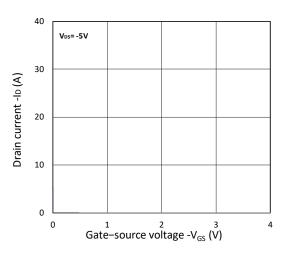


Figure 2. Transfer Characteristics

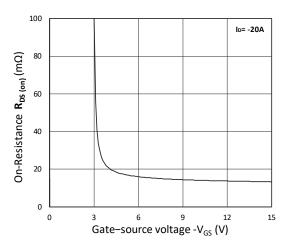


Figure 4. R<sub>DS(ON)</sub> vs. V<sub>GS</sub>

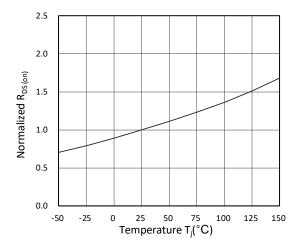


Figure 6. Normalized  $R_{DS(on)}$  vs. Temperature

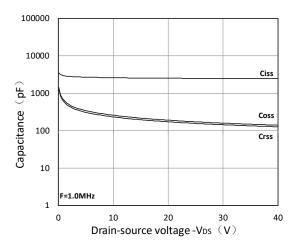


Figure 7. Capacitance Characteristics

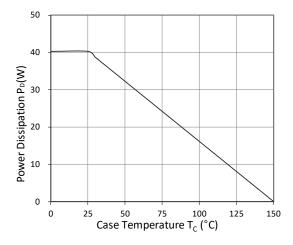


Figure 9. Power Dissipation

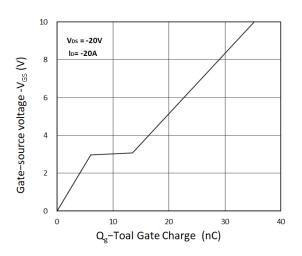


Figure 8. Gate Charge Characteristics

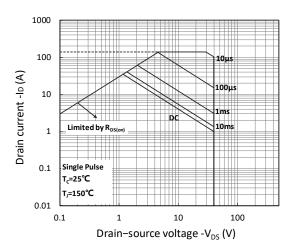


Figure 10. Safe Operating Area

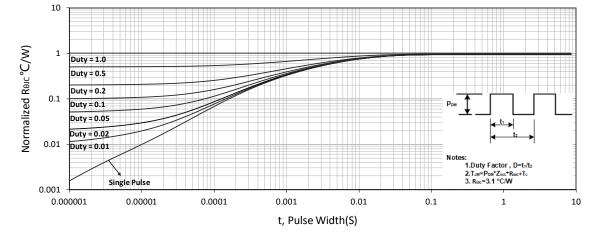


Figure 11. Normalized Maximum Transient Thermal Impedance



# **Test Circuit**

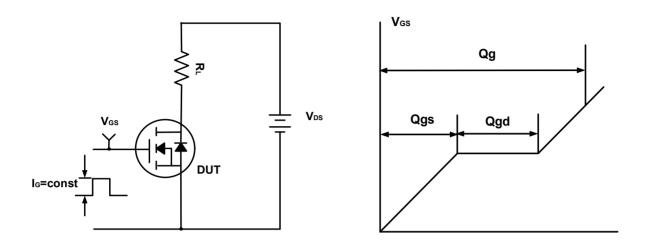


Figure A. Gate Charge Test Circuit & Waveforms

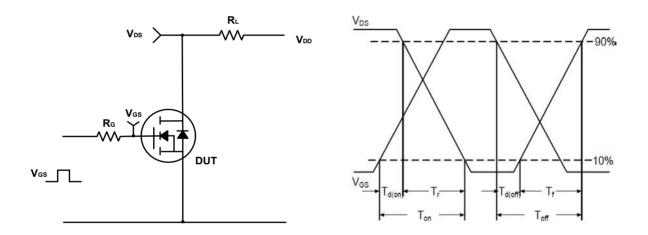


Figure B. Switching Test Circuit & Waveforms

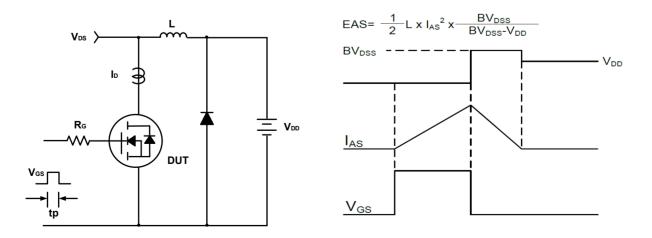
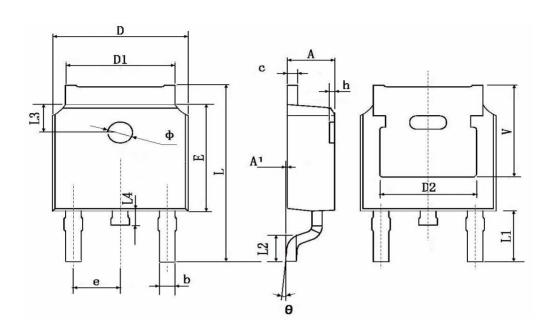


Figure C. Unclamped Inductive Switching Circuit & Waveforms



# TO252-2L(TO-252(DPAK)) Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches			
	Min.	Max.	Min.	Max.		
А	2.200	2.400	0.087	0.094		
A1	0.000	0.127	0.000	0.005		
b	0.660	0.860	0.026	0.034		
С	0.460	0.580	0.018	0.023		
D	6.500	6.700	0.256	0.264		
D1	5.100	5.460	0.201	0.215		
D2	4.830	4.830 TYP.		0.190 TYP.		
E	6.000	6.200	0.236	0.244		
е	2.186	2.386	0.086	0.094		
L	9.800	10.400	0.386	0.409		
L1	2.900	2.900 TYP.		0.114 TYP.		
L2	1.400	1.700	0.055	0.067		
L3	1.600 TYP.		0.063 TYP.			
L4	0.600	1.000	0.024	0.039		
Ф	1.100	1.300	0.043	0.051		
θ	0°	8°	0°	8°		
h	0.000	0.300	0.000	0.012		
V	5.350 TYP.		0.211 TYP.			



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